

1551892-2 ✓ ACTIVE



zQSFP+/QSFP28

TE Internal #: 1551892-2

QSFP, QSFP+ & zQSFP+, Cage Assembly, 1 x 1, Customer Applied Gasket, Standard, Data Rate (Max) 25 Gb/s, 1 Port, Pin, zQSFP+/QSFP28

[View on TE.com >](#)

Connectors > Pluggable IO Connectors & Cages > QSFP, QSFP+ & zQSFP+



Pluggable I/O Product Type: **Cage Assembly**
Port Matrix Configuration: **1 x 1**
EMI Containment Feature Type: **Customer Applied Gasket**
Thermal Accessory Type Included: **Heat Sink**
Included Lightpipe: **No**

Features

Product Type Features

Form Factor	QSFP28/56
Cage Type	Single
Pluggable I/O Product Type	Cage Assembly
Thermal Accessory Type Included	Heat Sink
Connector System	Cable-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Port Matrix Configuration	1 x 1
Number of Ports	1
Number of Rear EONs per Port Column	2

Electrical Characteristics

Data Rate (Max)	25 Gb/s
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Body Features



Heat Sink Finish	Anodized Black
Heat Sink Style	Pin
Heat Sink Height Class	SAN
Heat Sink Height	6.5 mm[.256 in]

Contact Features

PCB Contact Termination Area Plating Material	Tin
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Termination Features

Termination Post & Tail Length	2.05 mm[.081 in]
Termination Method to Printed Circuit Board	Through Hole - Press-Fit

Mechanical Attachment

Connector Mounting Type	Board Mount
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Housing Features

Cage Material	Nickel Silver
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Dimensions

PCB Thickness (Recommended)	1.45 mm[.057 in]
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Usage Conditions

Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]
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Operation/Application

For Use With Pluggable I/O Products	QSFP Cable Assembly, QSFP MSA Compatible Transceiver
Pluggable I/O Applications	SFP+ Stacked Belly-to-Belly
Circuit Application	Signal

Industry Standards

UL Flammability Rating	UL 94V-0
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Packaging Features

Packaging Method	Box & Tray
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Other

EMI Containment Feature Type	Customer Applied Gasket
Included Lightpipe	No
Enhancements	Standard



Product Compliance

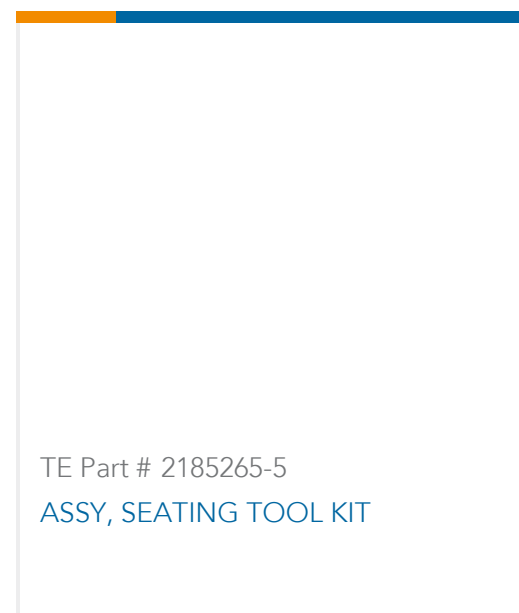
[For compliance documentation, visit the product page on TE.com>](#)

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not applicable for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

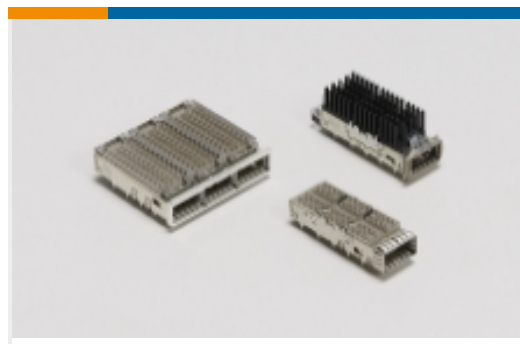
Compatible Parts



Also in the Series | [zQSFP+/QSFP28](#)



Pluggable I/O Cable Assemblies(81)

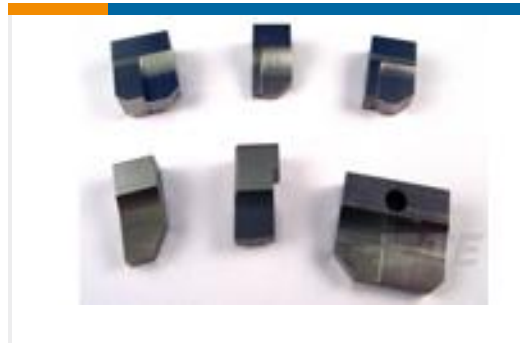


QSFP, QSFP+ & zQSFP+(432)

Customers Also Bought



TE Part #DTM13-12PA-G003
DEUTSCH DTM Headers



TE Part #1633923-5
ANVIL, COMBINATION



TE Part #2344054-2
PCIe Gen3.0 SMT type connector 30u" Au



TE Part #2363704-2
MBXLE R/A HEADER 12S+2P



TE Part #8-2355626-1
DDR5 DIMM BLACK HSG AND BLACK LATCH



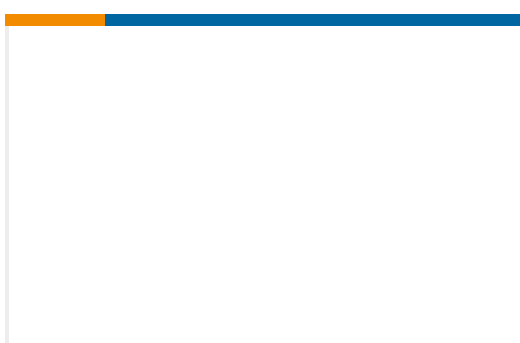
TE Part #1-5223986-0
KEYED R/A GUIDE SOCKET MODULE



TE Part #1-6450881-4
MBXLE R/A REC 12S+2P



TE Part #2057548-3
SFP+ Stout 1X4 Cage Assembly, Press-Fit



TE Part #8-2355644-1
DDR5 DIMM SMT_blue hsg&blue latch

Documents

Product Drawings

[Cage Assy Behind Bezel QSFP28](#)

English

CAD Files

[3D PDF](#)

[3D](#)

[Customer View Model](#)

[ENG_CVM_CVM_1551892-2_C.2d_dxf.zip](#)



English

Customer View Model

[ENG_CVM_CVM_1551892-2_C.3d_igs.zip](#)

English

Customer View Model

[ENG_CVM_CVM_1551892-2_C.3d_stp.zip](#)

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

Datasheets & Catalog Pages

[QSFP28/56 and zQSFP+ Interconnects](#)

English

Product Specifications

[Application Specification](#)

English

[Application Specification](#)

English

Product Environmental Compliance

[MD_1551892-2_02192018135_dmtec](#)

English

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English